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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Pendse	Attorney Docket No.: CPAC 1011-2
Application No.: 10/081,425	Examiner: Scott B. Geyer
Filed: 22 February 2002	Group: 2829
Title: Apparatus and Process for Precise Encapsulation of Flip Chip Interconnects	Confirmation No.: 9980
	Customer No. 22470

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OFFICE OF PETITIONS

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

It is requested that the information identified in this statement be considered by the Examiner and made of record in the above-identified application. This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. 1.56.

Enclosed with this statement is a Form PTO-SB/08/A. The Examiner is requested to initial the form and return it to the undersigned in accordance with M.P.E.P. 609.

Also enclosed is a copy of a PCT International Preliminary Examination Report mailed 08 July 2003 for a corresponding PCT Application.

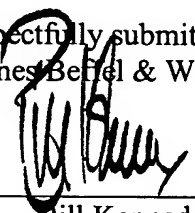
Also enclosed with this statement is a copy of each cited document as required by 37 C.F.R. 1.98.

This statement should be considered under 37 C.F.R. 1.97(b) because it is being filed before the mailing date of the first Office Action after the filing of a Request for Continued Examination under 37 C.F.R. 1.114.

Fee Authorization. The Commissioner is hereby authorized to charge any additional fees or credit any overpayment associated with this communication to Deposit Account No. 50-0869 (CPAC 1011-2).

Respectfully submitted,
Haynes Beffel & Wolfeld LLP

Date: 06 August 2003

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